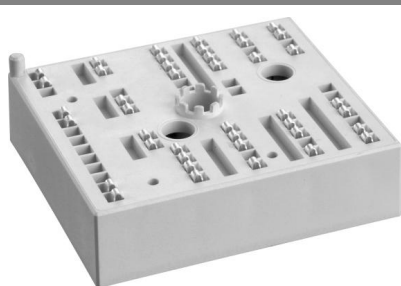


# SKiiP 24NAB126V10



MiniSKiiP® 2

3-phase bridge rectifier +  
brake chopper + 3-phase  
bridge inverter  
**SKiiP 24NAB126V10**

## Features

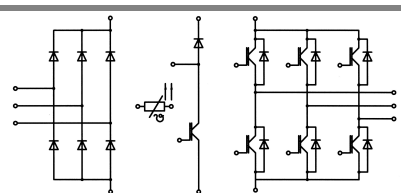
- Fast Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

## Typical Applications\*

- Inverter up to 19 kVA
- Typical motor power 11 kW

## Remarks

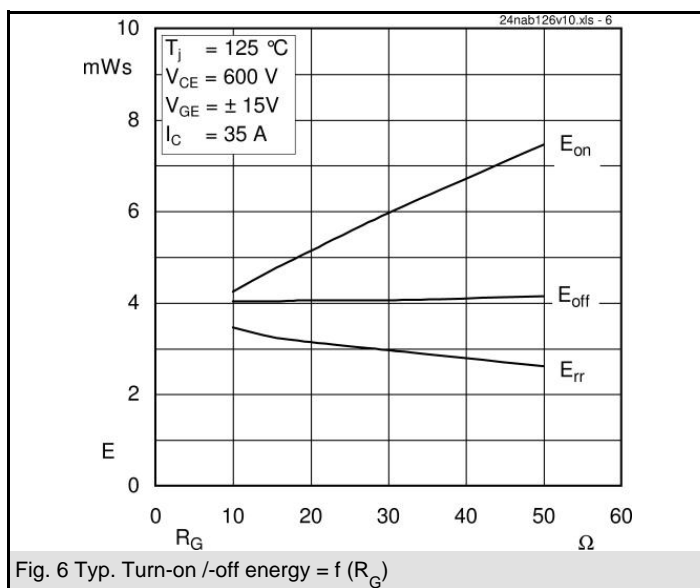
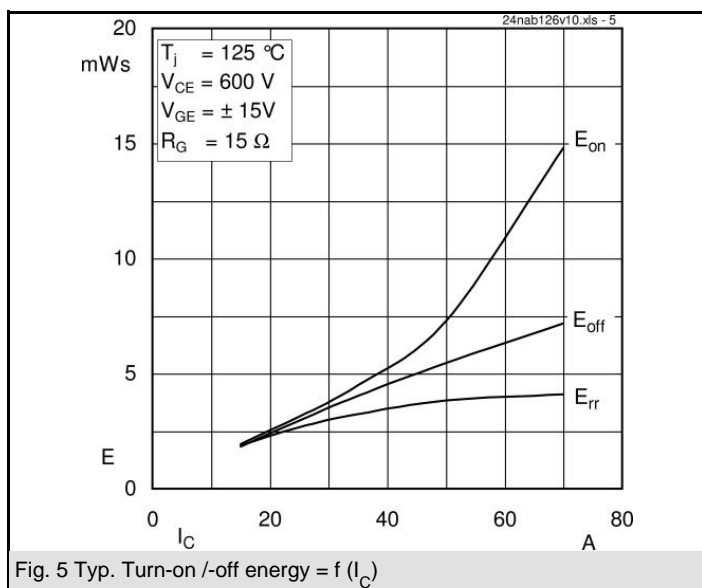
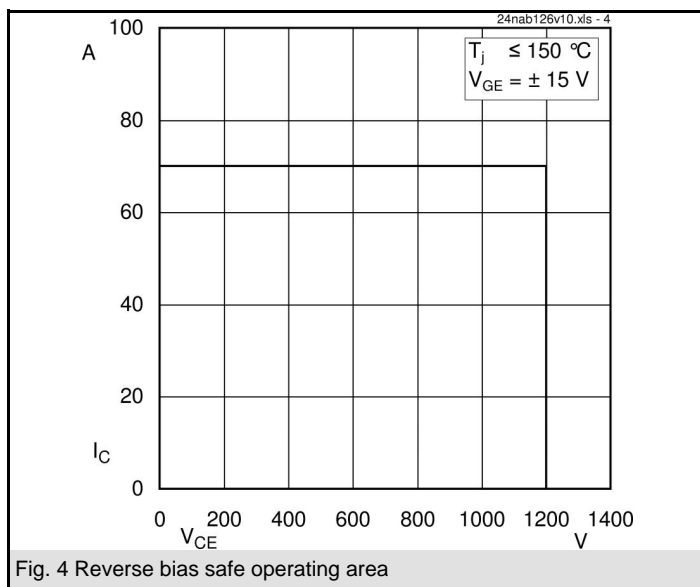
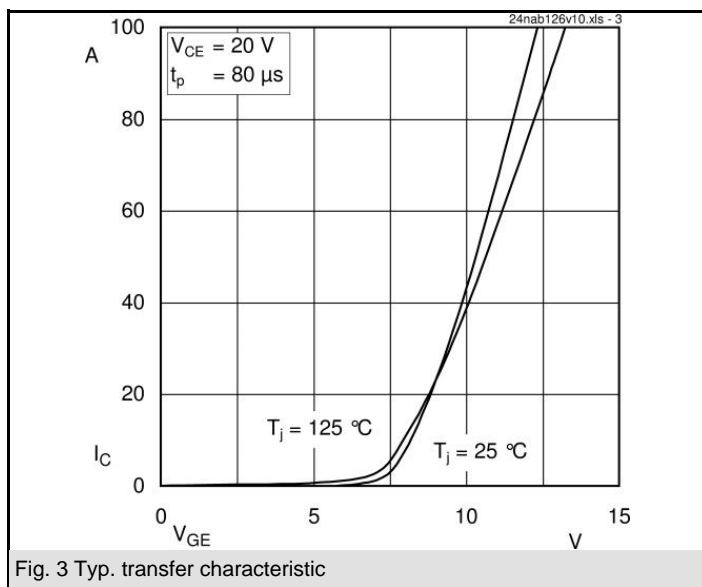
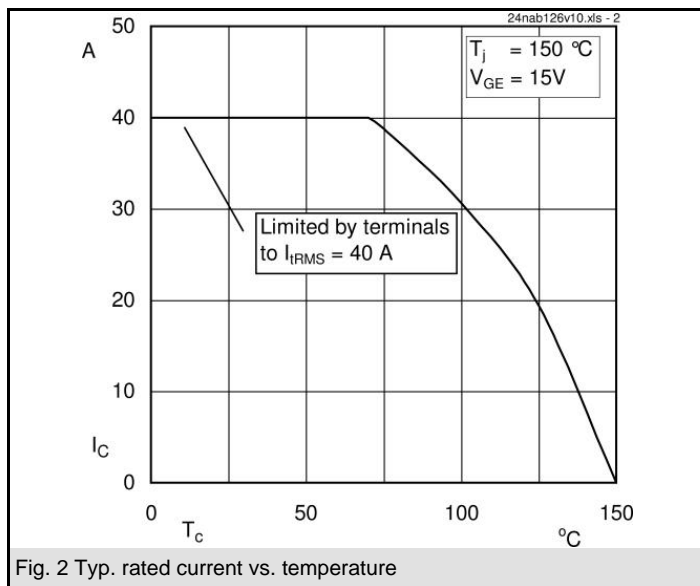
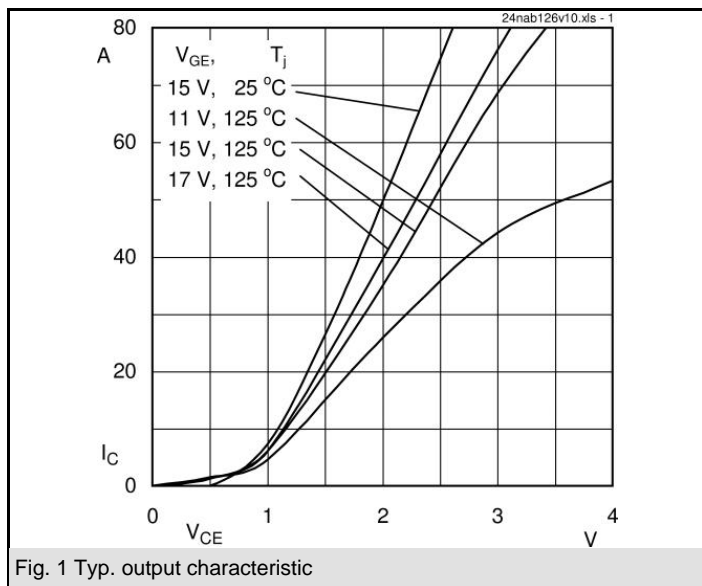
- $V_{CEsat}$ ,  $V_F$  = chip level value



NAB

Absolute Maximum Ratings		T <sub>s</sub> = 25 °C, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT - Inverter, Chopper			
V <sub>CES</sub>	T <sub>s</sub> = 25 (70) °C	1200	V
I <sub>C</sub>		52 (40)	A
I <sub>CRM</sub>		70	A
V <sub>GES</sub>		± 20	V
T <sub>j</sub>		- 40 ... + 150	°C
Diode - Inverter, Chopper			
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C	38 (29)	A
I <sub>FRM</sub>		70	A
T <sub>j</sub>		- 40 ... + 150	°C
Diode - Rectifier			
V <sub>RRM</sub>	T <sub>s</sub> = 70 °C	1600	V
I <sub>F</sub>		61	A
I <sub>FSM</sub>		700	A
i <sup>2</sup> t		2400	A <sup>2</sup> s
T <sub>j</sub>		- 40 ... + 150	°C
Module			
I <sub>tRMS</sub>	per power terminal (20 A / spring)	40	A
T <sub>stg</sub>		- 40 ... + 125	°C
V <sub>isol</sub>	AC, 1 min.	2500	V

Characteristics		$T_s = 25\text{ °C}$ , unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT - Inverter, Chopper</b>					
$V_{CEsat}$	$I_{Cnom} = 35\text{ A}$ , $T_j = 25\text{ (125) °C}$		1,7 (2)	2,1 (2,4)	V
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 1,5\text{ mA}$	5	5,8	6,5	V
$V_{CE(TO)}$	$T_j = 25\text{ (125) °C}$		1 (0,9)	1,2 (1,1)	V
$r_T$	$T_j = 25\text{ (125) °C}$		20 (31)	26 (37)	mΩ
$C_{ies}$	$V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$		2,4		nF
$C_{oes}$	$V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$		0,5		nF
$C_{res}$	$V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$		0,3		nF
$R_{th(j-s)}$	per IGBT		0,75		K/W
$t_{d(on)}$	under following conditions		80		ns
$t_r$	$V_{CC} = 600\text{ V}$ , $V_{GE} = \pm 15\text{ V}$		30		ns
$t_{d(off)}$	$I_{Cnom} = 35\text{ A}$ , $T_j = 125\text{ °C}$		410		ns
$t_f$	$R_{Gon} = R_{Goff} = 15\text{ Ω}$		120		ns
$E_{on}$	inductive load		4,6		mJ
$E_{off}$			4		mJ
<b>Diode - Inverter, Chopper</b>					
$V_F = V_{EC}$	$I_{Fnom} = 35\text{ A}$ , $T_j = 25\text{ (125) °C}$		1,8 (1,8)	2,1 (2,2)	V
$V_{(TO)}$	$T_j = 25\text{ (125) °C}$		1 (0,8)	1,1 (0,9)	V
$r_T$	$T_j = 25\text{ (125) °C}$		23 (31)	29 (37)	mΩ
$R_{th(j-s)}$	per diode		1,5		K/W
$I_{RRM}$	under following conditions		43		A
$Q_{rr}$	$I_{Fnom} = 35\text{ A}$ , $V_R = 600\text{ V}$		7		μC
$E_{rr}$	$V_{GE} = 0\text{ V}$ , $T_j = 125\text{ °C}$		3,3		mJ
	$di_F/dt = 1450\text{ A/μs}$				
<b>Diode - Rectifier</b>					
$V_F$	$I_{Fnom} = 35\text{ A}$ , $T_j = 25\text{ °C}$		1,1		V
$V_{(TO)}$	$T_j = 150\text{ °C}$		0,8		V
$r_T$	$T_j = 150\text{ °C}$		11		mΩ
$R_{th(j-s)}$	per diode		0,9		K/W
<b>Temperature Sensor</b>					
$R_{ts}$	3 %, $T_r = 25\text{ (100) °C}$		1000(1670)		Ω
<b>Mechanical Data</b>					
w			65		g
$M_s$	Mounting torque	2		2,5	Nm



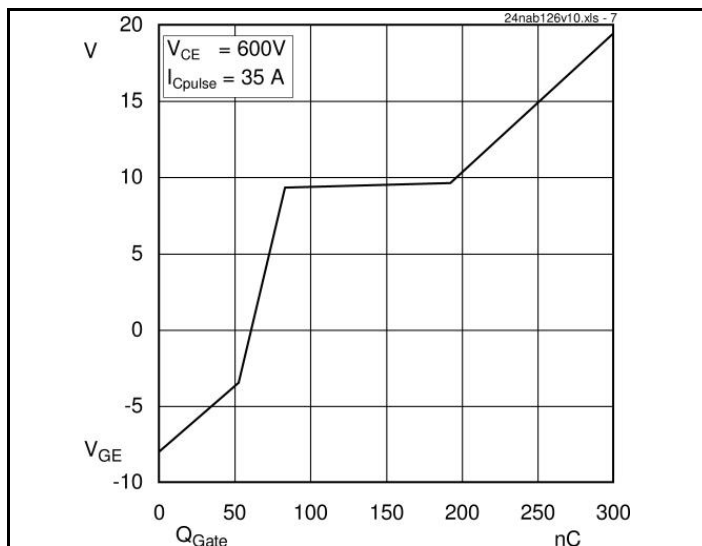


Fig. 7 Typ. gate charge characteristic

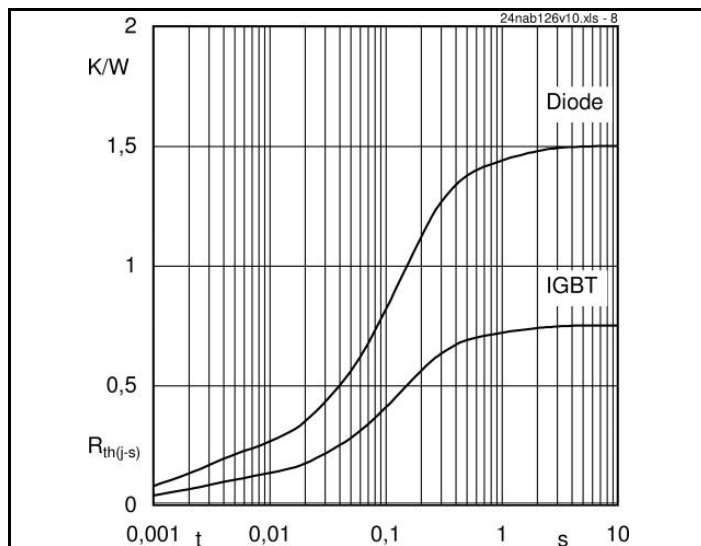


Fig. 8 Typ. thermal impedance

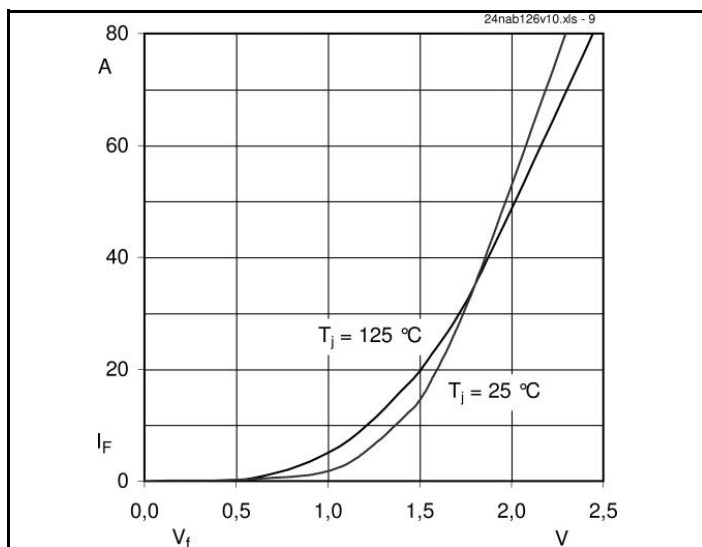


Fig. 9 Typ. freewheeling diode forward characteristic

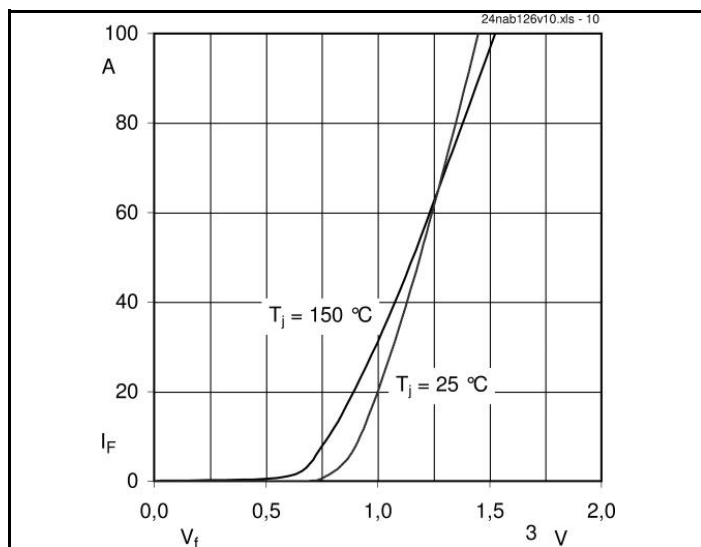
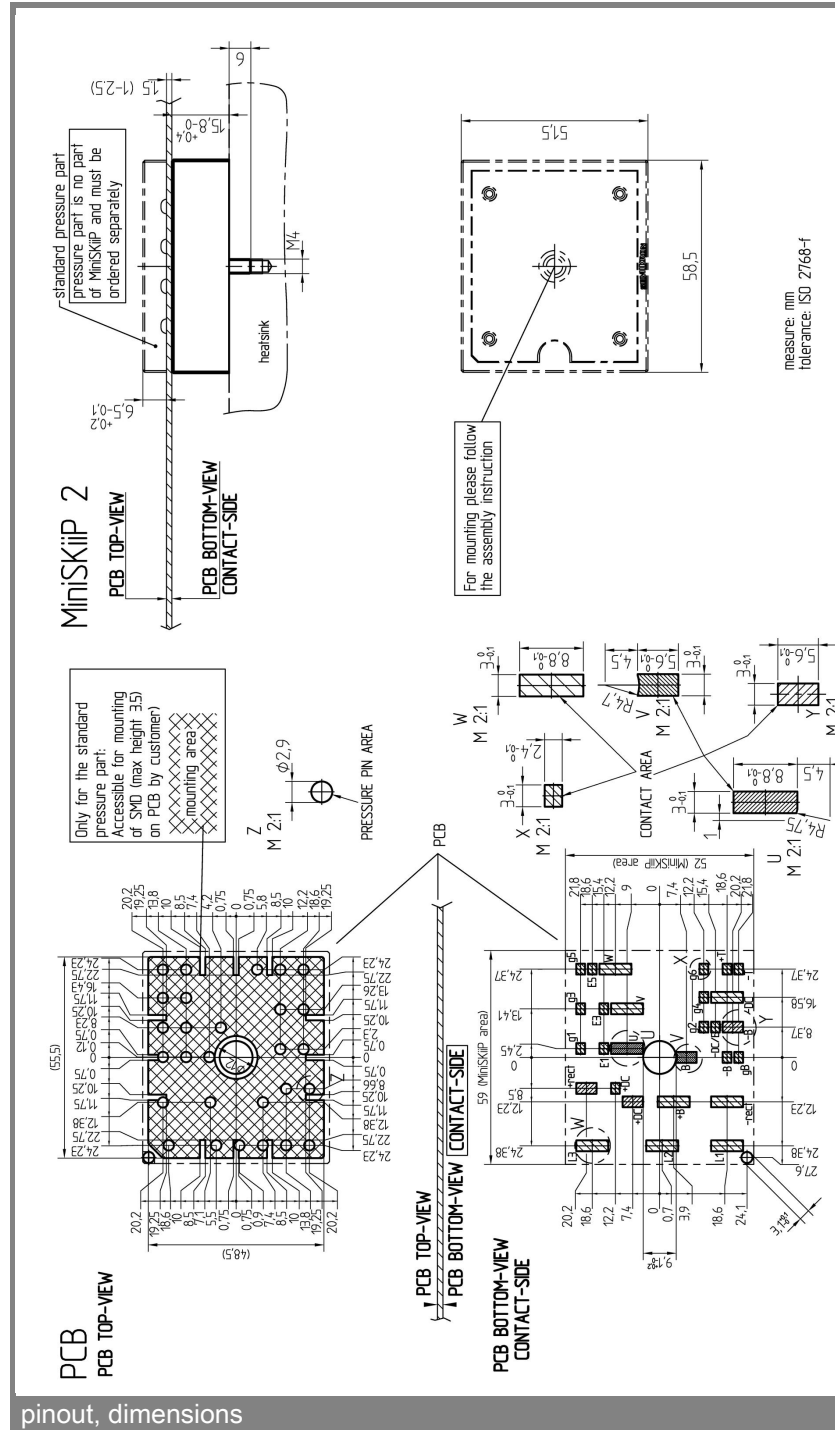
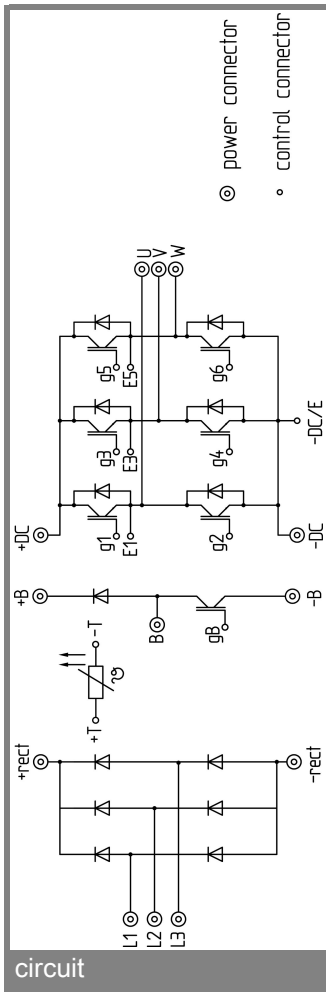


Fig. 10 Typ. input bridge forward characteristic



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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